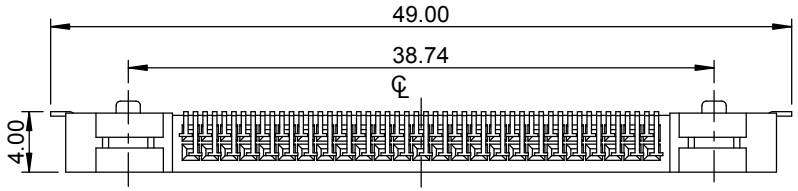
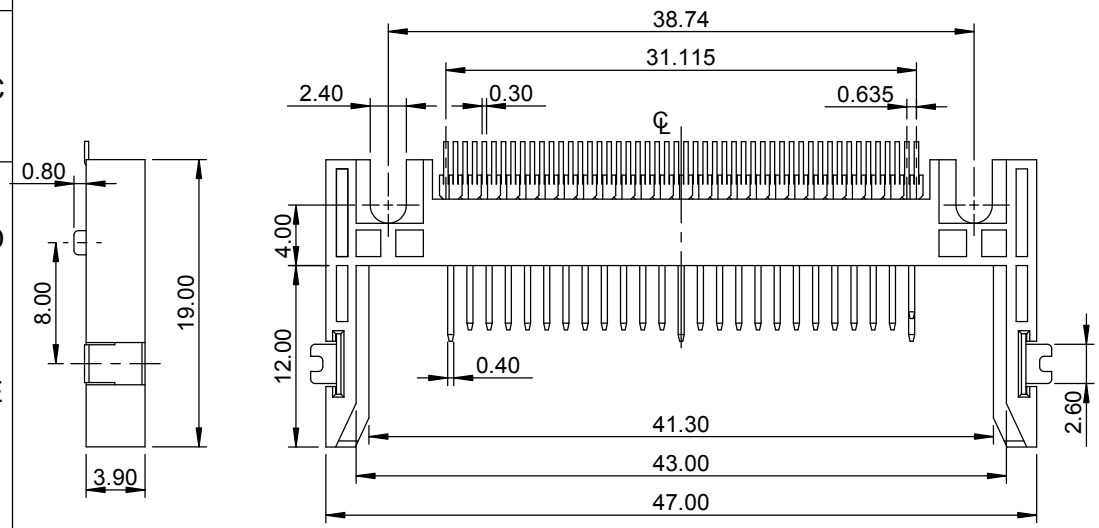
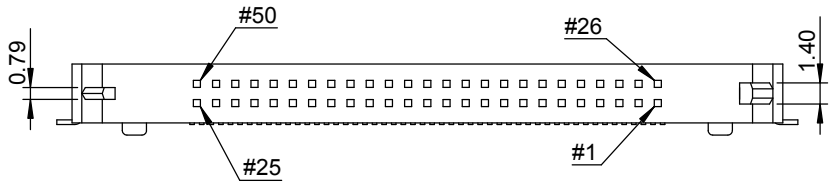
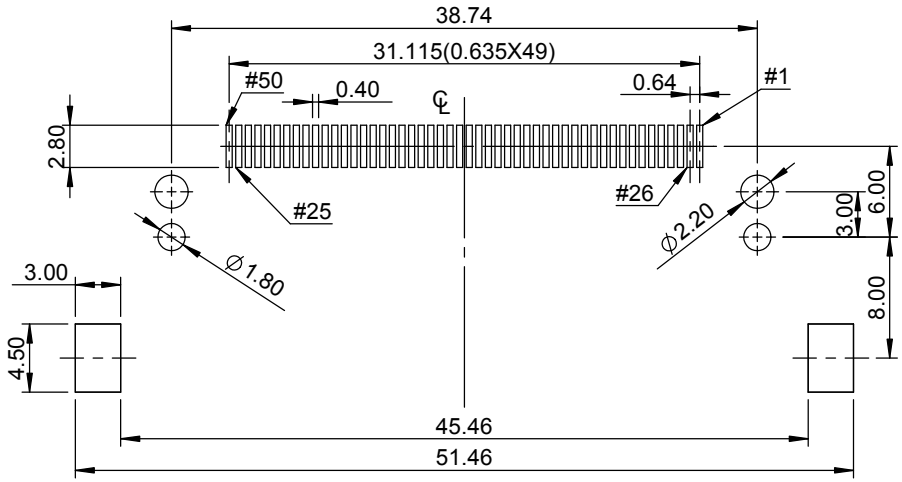
更改 REV	設 變 內 容 MODIFICATION
A	ECN01753
B	ECN01934



NOTES:
1. MATERIAL:
   INSULATOR: HIGH TEMPRATURE THERMOPLASTIC, UL94V-0
   CONTACT: COPPER ALLOY
   PAD: BRASS
2. PLATING:
   SOLDER AREA: Tin PLATED OVER Ni
3.PART NO : 7CFHD- X 9-9101
   F : Gold Flash Au PLATED OVER Ni
   B : 10μ" Au PLATED OVER Ni







PCB LAYOUT

Pin Assignment:		
Pin Type	Interface Dim.	Pin No.
Detect	3.50mm	25 , 26
General	4.25mm	The Others
Pow er	5.00mm	1 , 13 , 38 , 50

GENERIAL TOLERANCE		KINGCONN 皇海科技股份有限公司		
X.± 0.50	X.°± 5°			
.X± 0.30	.X°± 2°	名 稱(TITLE) CF CARD HEADER Reverse CONNECTOR		
.XX± 0.20	.XX°± 1°			
單 位(UNIT) mm	料 號(PART NO.) 7CFHD-X9-9101		圖 號(DWG NO.) 7CFHD-X9-9101-B	
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	比 例 SCALE 2:1	張 數 SHEET 1 / 1
			角 法 PROJ.	更 改 REV B